

Ph RoHS

General Description

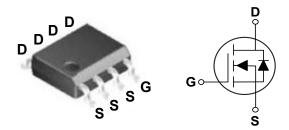
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV _{DSS}	R _{DS(ON)}	I _D
60 V	50 mΩ	5.5 A

Features

- $R_{DS(ON)} \leq 50 m \Omega @V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

SOP-8 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting

Absolute Maximum Ratings T_c=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I.	Drain Current - Continuous (T _C =25°C)	5.5	А
I _D	Drain Current - Continuous (T _C =100°C)	3.5	А
I _{DM}	Drain Current - Pulsed (NOTE 1)	22	А
EAS	Single Pulse Avalanche Energy (NOTE 2)	11	mJ
IAS	Single Pulse Avalanched Current (NOTE 2)	15	А
P _D	Power Dissipation (T _C =25°C)	1.66	W
' D	Power Dissipation - Derate above 25°C	0.0133	W/°C
TJ	Operating Junction Temperature Range	-50 to 150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
Marking Code		NG050 , DS6910	

Thermal Characteristics

Symbol	Parameter Typ.		Max.	Unit
$R_{ extsf{ heta}JA}$	Thermal Resistance Junction to Ambient		75	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case		35	°C/W





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Chara	Off Characteristics						
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V	
I _{DSS}	Drain-Source Leakage Current	V_{DS} =60V , V_{GS} =0V , T_J =25°C			1	uA	
		V_{DS} =48V , V_{GS} =0V , T _J =125°C			10	uA	
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA	

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	IStatic Drain-Source On-Resistance	V _{GS} =10V , I _D =8A		43	50	mΩ
		V _{GS} =4.5V , I _D =4A		50	60	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250$ uA	1.2	1.8	2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =4A		6.5		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge			14	21	
Q_{gs}	Gate-Source Charge	────V _{DS} =30V , V _{GS} =10V , I _D =4A ────(NOTE 3)		2.9	5	nC
Q_{gd}	Gate-Drain Charge	(NOTE 3)		2.3	4	
T _{d(on)}	Turn-On Delay Time			3.9	7	
Tr	Rise Time	V_{DD} =30V , V_{GS} =10V , R_{G} =3.3 Ω ,		12.6	24	nS
T _{d(off)}	Turn-Off Delay Time	I _D =1A (NOTE 3)		23.1	44	113
T _f	Fall Time			6.7	13	
C _{iss}	Input Capacitance			800	1160	
C_{oss}	Output Capacitance	V_{DS} =15V , V_{GS} =0V , F=1MHz		380	550	pF
C _{rss}	Reverse Transfer Capacitance			115	170	
R _g	Gate resistance	V_{GS} =0V , V_{DS} =0V , F=1MHz		1.7	3.4	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current	$V_{G}=V_{D}=0V$, Force Current			5.5	А
I _{SM}	Pulsed Source Current				11	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C			1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

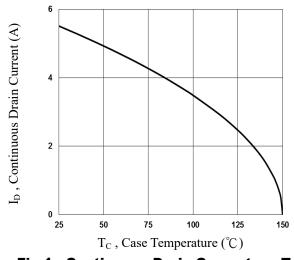
2. V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=15A, R_G=25\Omega, Starting T_J=25^{\circ}C.

3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.



Pb RoHS

Characteristics Curves





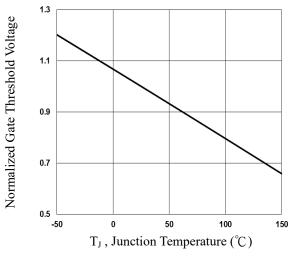
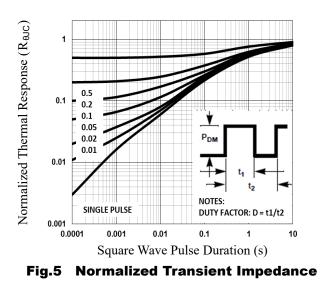


Fig.3 Normalized V_{th} vs. T_J



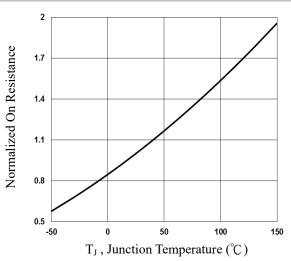


Fig.2 Normalized RDSON vs. T_J

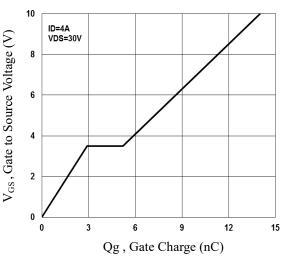
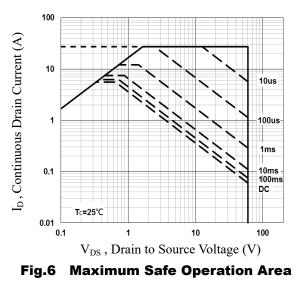


Fig.4 Gate Charge Waveform

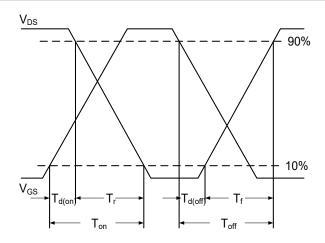




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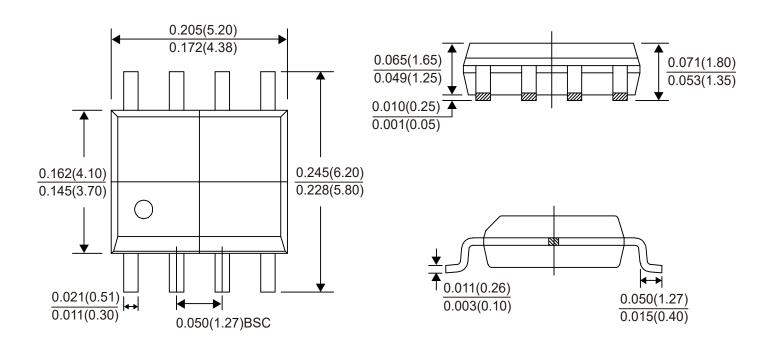
60V N-Channel MOSFETs

Characteristics Curves





Package Outline Dimensions



SOP-8 Dimensions in inches and (millimeters)



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